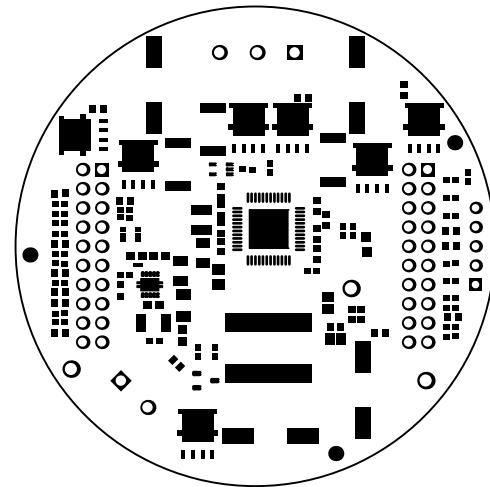
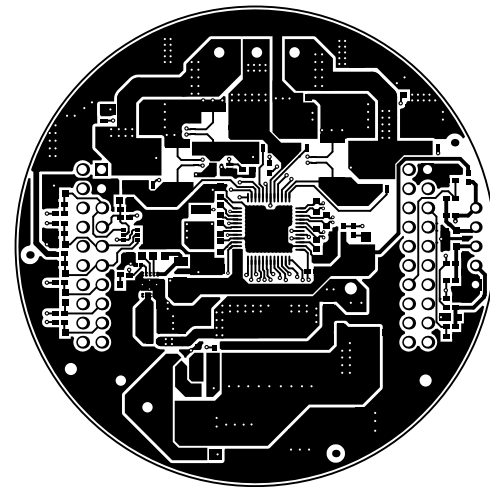


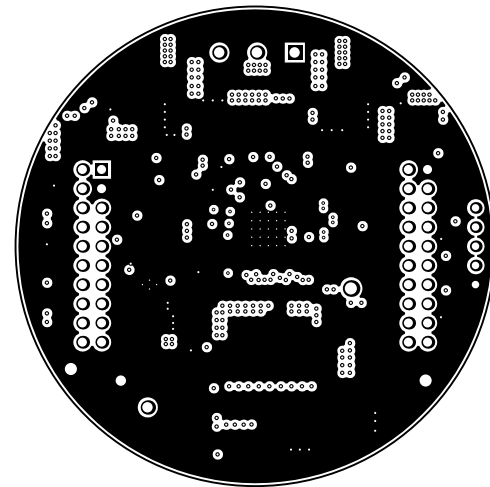
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00901	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TIDA-00901		
PLOT NAME = Top Overlay	GENERATED : 3/16/2016	11:08:57 AM	TEXAS INSTRUMENTS



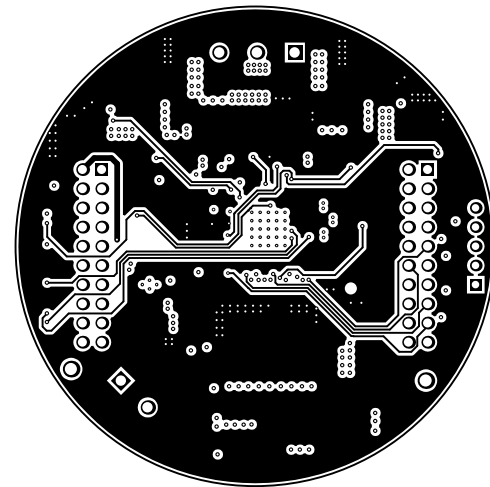
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00901	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDA-00901		
PLOT NAME = Top Solder Mask	GENERATED : 3/16/2016 11:08:58 AM	TEXAS INSTRUMENTS	



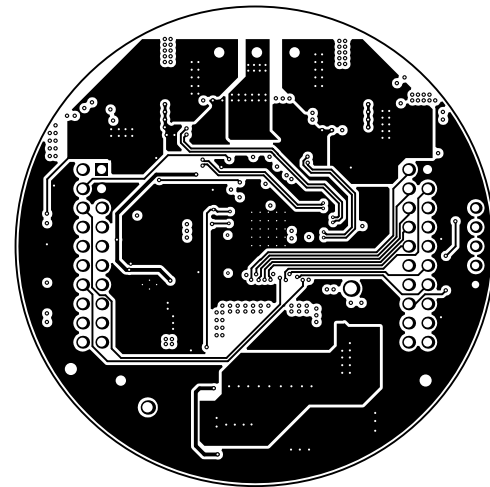
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00901	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: TIDA-00901		
PLOT NAME = Top Layer	GENERATED : 3/16/2016 11:08:59 AM	TEXAS INSTRUMENTS	



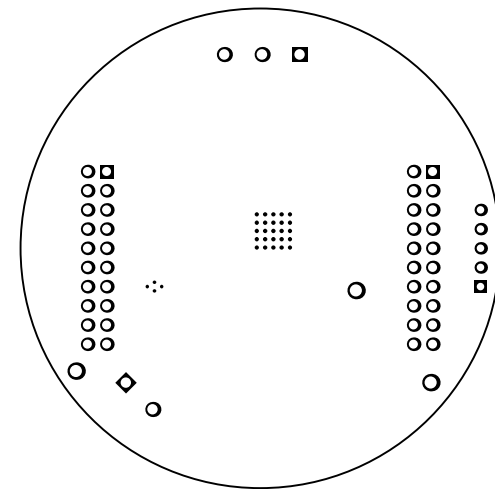
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00901	REV: E1	SUN REV: Not In VersionControl
LAYER NAME =	TID #: TIDA-00901		
PLOT NAME = Signal Layer 1	GENERATED : 3/16/2016 11:09:00 AM	TEXAS INSTRUMENTS	



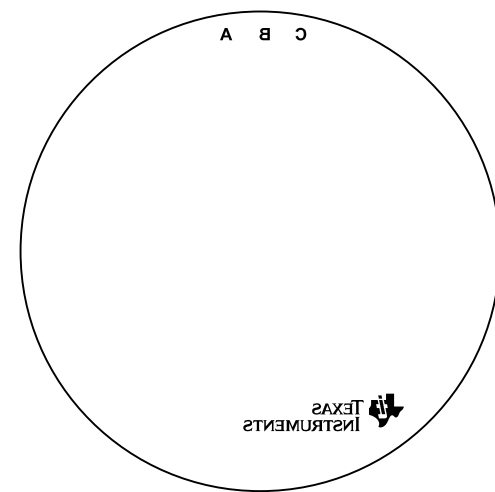
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00901	REV: E1	SUN REV: Not In VersionControl
LAYER NAME =	TID #: TIDA-00901		
PLOT NAME = Signal Layer 2	GENERATED : 3/16/2016 11:09:01 AM	TEXAS INSTRUMENTS	



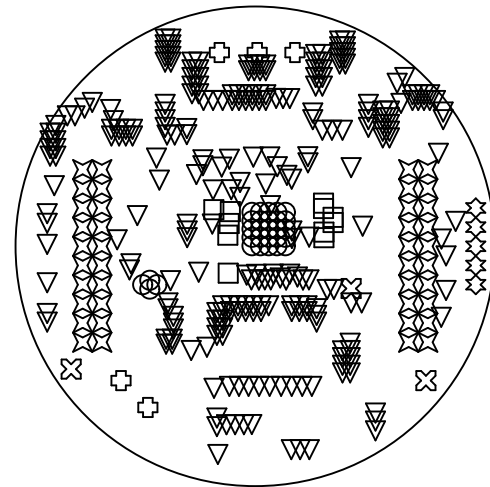
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00901	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: TIDA-00901		
PLOT NAME = Bottom Layer	GENERATED : 3/16/2016 11:09:02 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00901	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA-00901		
PLOT NAME = Bottom Solder Mask	GENERATED : 3/16/2016 11:09:03 AM	TEXAS INSTRUMENTS	

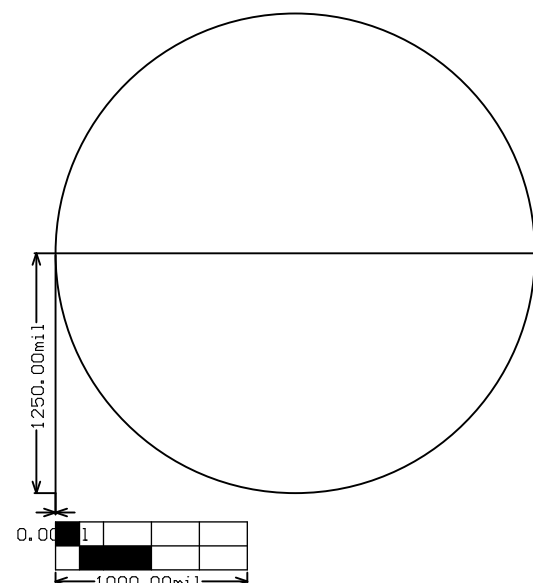


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00901	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: TIDA-00901		
PLOT NAME = Bottom Overlay	GENERATED : 3/16/2016 11:09:04 AM	TEXAS INSTRUMENTS	



Symbol	Quantity	Finished Hole Size	Plated	Hole Type
○	29	7.87mil (0.200mm)	PTH	Round
□	11	10.00mil (0.254mm)	PTH	Round
▽	267	12.00mil (0.305mm)	PTH	Round
✱	5	40.16mil (1.020mm)	PTH	Round
✱	40	47.24mil (1.200mm)	PTH	Round
⊗	5	55.12mil (1.400mm)	PTH	Round
⊗	3	63.00mil (1.600mm)	PTH	Round
360 Total				

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00901	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TIDA-00901		
PLOT NAME = Drill Drawing	GENERATED : 3/16/2016	11:09:05 AM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00901	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: TIDA-00901		
PLOT NAME = Board Dimensions	GENERATED : 3/16/2016 11:09:06 AM	TEXAS INSTRUMENTS	

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